<u>TOSHIBA</u>

TOSHIBA Field Effect Transistor Silicon P, N Channel MOS Type (U-MOS III / π -MOS VI)

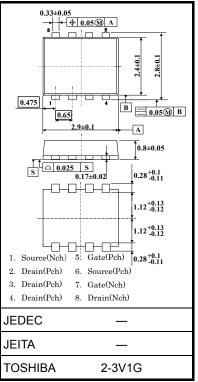
TPCP8401

- Switching Regulator Applications
- \bigcirc Load Switch Applications
- Lead(Pb)-Free
- Multi-chip discrete device; built-in P channel MOS FET for main switch and N Channel MOS FET for drive
- Small footprint due to small and thin package
- Low drain-source ON resistance
 P Channel RDS (ON) = 31 mΩ (typ.)
- Low drain-source ON resistance High forward transfer admittance
 P Channel |Y_{fs}| = 13 S (typ.)
- Low leakage current
 P Channel IDSS = -10 µA (VDS = -12 V)
- Enhancement-mode : P Channel V_{th} = -0.5 to -1.2 V (V_{DS} = -10 V, I_D = -200 μA)

Absolute Maximum Ratings (Ta = 25°C)

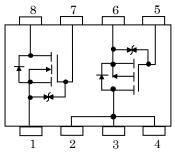
P-ch

Characteristics		Symbol	Rating	Unit
Drain-source voltage		V _{DSS}	-12	V
Drain-gate voltage (R	t _{GS} = 20 kΩ)	V _{DGR}	-12	V
Gate-source voltage		V _{GSS}	±8	V
Drain current	DC (Note 1)	ID	-5.5	А
Drain current	Pulse (Note 1)	I _{DP}	-22.0	A
Drain power dissipation	on (t = 5 s) (Note 2a)	PD	1.96	W
Drain power dissipation	on (t = 5 s) (Note 2b)	PD	1.0	W
Single pulse avalanch	ne energy (Note 3)	E _{AS}	5.3	mJ
Avalanche current		I _{AR}	-2.8	А
Repetitive avalanche energy (Note 2a) (Note 4)		E _{AR}	0.22	mJ
Channel temperature		T _{ch}	150	°C

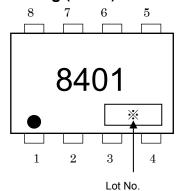


Weight: 0.017 g (typ.)

Circuit Configuration



Marking (Note5)



Unit: mm

N-ch

Characteristics			Symbol	Rating	Unit	
Drain-source v	voltage		V _{DSS}	20	V	
Gate-source v	oltage		V _{GSS}	±10	V	
Drain current	DC	(Note 1)	۱ _D	0.1	А	
	Pulse	(Note 1)	I _{DP}	0.2	A	
Channel temp	Channel temperature			150	°C	
Repetitive avalanche energy Single-device value at dual operation (Note 2a, 3b, 5)			E _{AR}	0.12	mJ	
Channel temperature			T _{ch}	150	°C	

This transistor is an electrostatic-sensitive device. Handle with caution.

Common Absolute Maximum Ratings (Ta=25°C)

Characteristics	Symbol	Rating	Unit
Storage temperature range	T _{stg}	-55~150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient $(t = 5 s)$ (Note 2a)	R _{th (ch-a)}	63.8	°C/W
Thermal resistance, channel to ambient $(t = 5 s)$ (Note 2b)	R _{th (ch-a)}	125	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: (a) Mounted on FR4 board (glass epoxy, 0.8mm thick, Cu area: 25.4mm2) (t = 5s) (b) Mounted on FR4 board (glass epoxy, 0.8mm thick, printed minimum pad dimensions: 25.4mm2) (t = 5s)

Note 3: $V_{DD} = -10 \text{ V}, \text{ T}_{ch} = 25^{\circ}\text{C}$ (initial), L = 0.5 mH, R_G = 25 Ω , I_{AR} = -2.75 A

Note 4: Repetitive rating: pulse width limited by maximum channel temperature

Note 5: "●" on the lower left of the marking indicates pin 1. "*" shows the lot number, which consists of three digits. The first digit denotes the year of manufacture, expressed as the last digit of the calendar year; the next two digits denote the week of manufacture.



Week of manufacture – (01 for the first week of year, continuing up to 52 or 53)

Year of manufacture

(The last digit of the calendar year)

Electrical Characteristics (Ta = 25°C)

P-ch

Cha	aracteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I _{GSS}	$V_{GS}=\pm 8~V,~V_{DS}=0~V$	_		±10	μA
Drain cut-off curr	ent	IDSS	$V_{DS} = -12 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			-10	μA
Drain-source breakdown voltage		V (BR) DSS	$I_D = -10$ mA, $V_{GS} = 0$ V	-12			v
		V (BR) DSX	$I_D = -10 \text{ mA}, \text{ V}_{GS} = 20 \text{ V}$	-4		_	v
Gate threshold ve	oltage	V _{th}	$V_{DS}=-10~V,~I_D=-200~\mu A$	-0.5		-1.2	V
			$V_{GS} = -1.8 \text{ V}, I_D = -1.4 \text{ A}$		66	103	
Drain-source ON	resistance	R _{DS (ON)}	$V_{GS}=-2.5 \text{ V}, \text{ I}_{D}=-2.8 \text{ A}$	—	44	58	mΩ
			$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -2.8 \text{ A}$		31	38	
Forward transfer admittance		Y _{fs}	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -2.8 \text{ A}$	6.5	13	_	S
Input capacitance		C _{iss}	V _{DS} = -10 V, V _{GS} = 0 V, f = 1 MHz	_	1520	_	pF
Reverse transfer capacitance		C _{rss}			330	_	
Output capacitan	се	C _{oss}		_	380		
	Rise time	tr	$V_{GS} \xrightarrow{0}_{-5} V \xrightarrow{I_D = -2.8 \text{ A}}_{C} \xrightarrow{0}_{-5} V \xrightarrow{0}_{-5} \xrightarrow{V}_{-5} \xrightarrow{V}_{-5}$	_	9.5		
Switching time	Turn-on time	t _{on}		_	16	_	20
Switching time	Fall time	t _f		_	28	_	ns
	Turn-off time	t _{off}	000 = 000 Duty≦ 1%, t _w = 10 μs	_	74	_	
Total gate charge (gate-source plus gate-drain)		Qg	$V_{DD} \simeq -10 \text{ V}, \text{ V}_{GS} = -5 \text{ V},$		20		
Gate-source charge 1		Q _{gs1}	$I_{\rm D} = -5.5 \rm{A}$		15		nC
Gate-drain ("miller") charge		Q _{gd}		_	5	—	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current (pulse) (Note 1)	I _{DRP}	—	_	_	-22	А
Forward voltage (diode)	V _{DSF}	$I\mathrm{DR}$ = –5.5 A, VGS = 0 V			1.2	V

N-ch

Cha	aracteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		IGSS	V_{GS} = ±10 V, V_{DS} = 0 V		—	±1	μA
Drain cut-off curre	ent	IDSS	V _{DS} = 20 V, V _{GS} = 0 V		_	1	μA
Drain-source brea	akdown voltage	$V\left(_{BR}\right)\mathrm{DSS}$	I _D = 0.1 mA, V _{GS} = 0 V	20	_		V
Gate threshold vo	ltage	Vth	V _{DS} = 3 V, I _D = 0.1 mA	0.6	_	1.1	V
			V _{GS} = 1.5 V, I _D = 1 mA		5.2	15	
Drain-source ON	resistance	RDS (ON)	V _{GS} = 2.5 V, I _D = 10 mA		2.2	4	Ω
			V _{GS} = 4 V, I _D = 10 mA	_	1.5	3	1
Forward transfer admittance		Y _{fs}	V _{DS} = 3 V, I _D = 10 mA	40	_	_	mS
Switching time	Turn-on time	t _{on}	$V_{GS} \begin{array}{c} 2.5 \text{ V} \\ 0 \text{ V} \end{array} \begin{array}{c} I_D = 10 \text{ mA} \\ \hline & & O \text{ VOUT} \end{array} \end{array} \begin{array}{c} - \\ & & O \text{ VOUT} \end{array}$		70	_	
	Turn-off time	t _{off}			125		ns
Input capacitance		C _{iss}		_	9.3		
Reverse transfer capacitance		C _{rss}	V _{DS} = 3 V, V _{GS} = 0 V, f = 1 MHz	—	4.5		pF
Output capacitance		C _{oss}]	_	9.8	—	

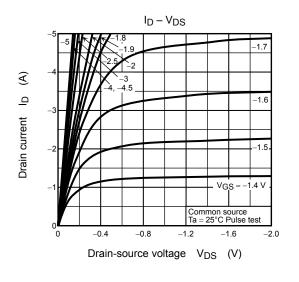
Precaution

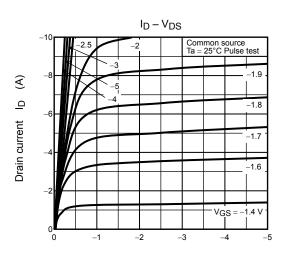
 $V_{th} \ \text{can be expressed as the voltage between the gate and source when the low operating current value is I_D = 100 \ \mu\text{A} \ \text{for this product.} \ \text{For normal switching operation}, V_{GS} \ \text{(on)} \ \text{requires a higher voltage than} \ V_{th} \ \text{and} \ V_{GS} \ \text{(off)} \ \text{requires a lower voltage than} \ V_{th}.$ (The relationship can be established as follows: $V_{GS} \ \text{(off)} < V_{th} < V_{GS} \ \text{(on)}.$)

Be sure to take this into consideration when using the device. The V_{GS} recommended voltage for turning on this product is 1.5 V or higher.

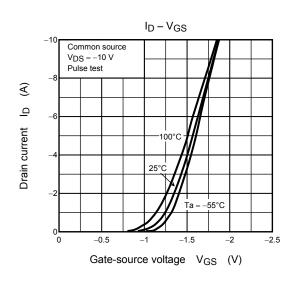
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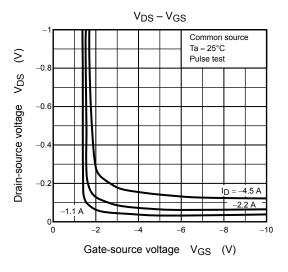
Pch

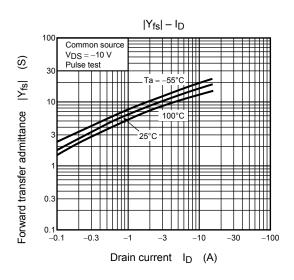


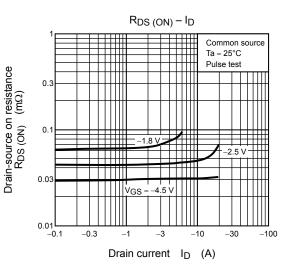


Drain-source voltage V_{DS} (V)

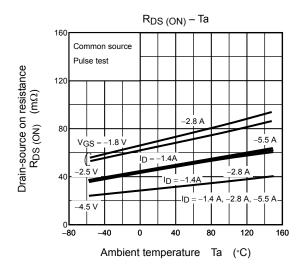


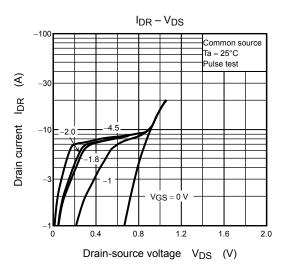


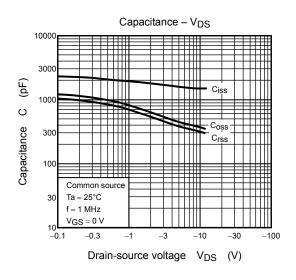


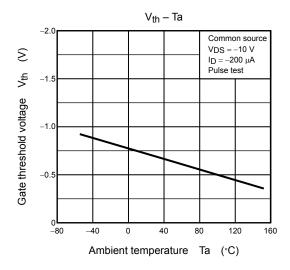


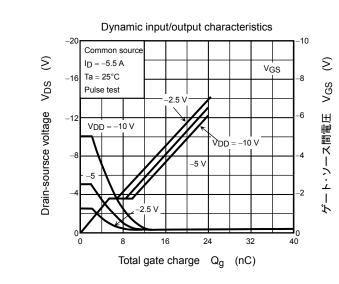
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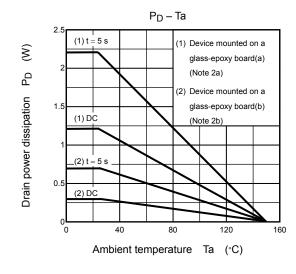




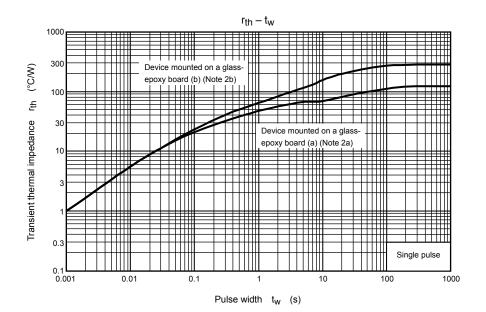




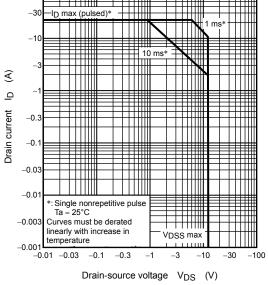




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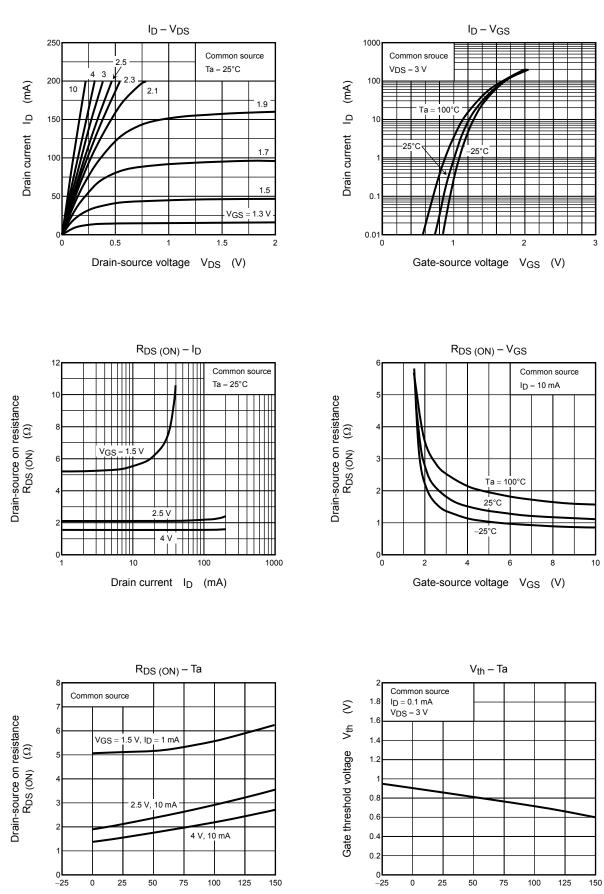


Safe operating area



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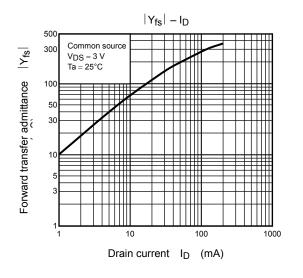
Ambient temperature

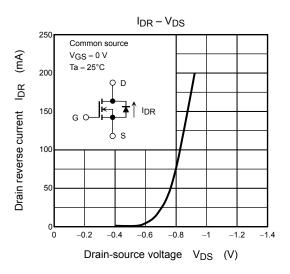
Ta (°C)

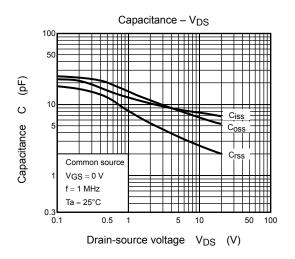
Ambient temperature

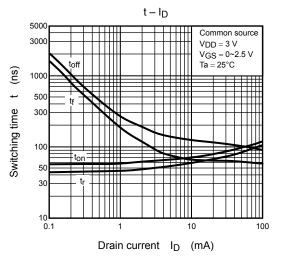
Ta (°C)

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